

ASM3P2107A

Peak EMI Reducing Solution

Features

- FCC approved method of EMI attenuation.
- Generates a 1X low EMI spread spectrum clock of the input frequency.
- Input frequency range: 12MHz to 22MHz.
- Internal loop filter minimizes external components and board space.
- Frequency deviation: 0.8%(Typ) @ 20MHz.
- Low cycle-to-cycle jitter.
- 5.0V ± 5% operating voltage range.
- TTL or CMOS compatible outputs.
- Available in 8-pin TSSOP and SOIC package.

Product Description

The ASM3P2107A is a versatile spread spectrum frequency modulator designed specifically for input clock frequencies from 12MHz to 22MHz. The ASM3P2107A can generate an EMI reduced clock from crystal, ceramic resonator, or system clock.

The ASM3P2107A reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of down stream clock and data dependent signals. The ASM3P2107A allows significant system cost savings

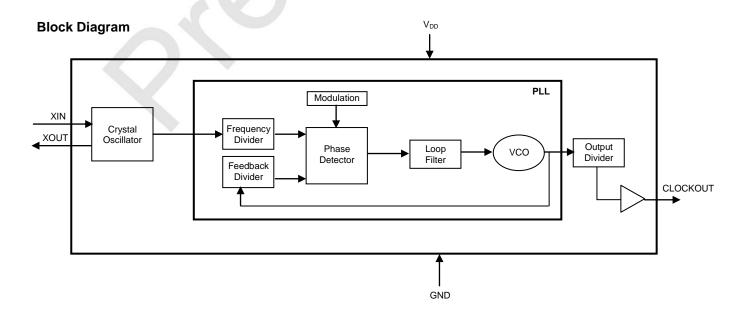
by reducing the number of circuit board layers ferrite beads, shielding and other passive components that are traditionally required to pass EMI regulations.

The ASM3P2107A uses the most efficient and optimized modulation profile approved by the FCC and is implemented in a proprietary all digital method.

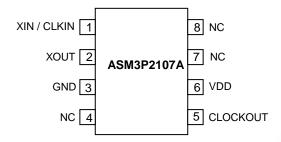
The ASM3P2107A modulates the output of a single PLL in order to "spread" the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is called 'spread spectrum clock generation.'

Applications

The ASM3P2107A is targeted towards EMI management for high speed digital applications such as PC peripheral devices, consumer electronics and embedded controller systems.



Pin Configuration



Pin Description

| III 2000 iipiioii | | | | | | |
|-------------------|-------------|------|--|--|--|--|
| Pin# | Pin Name | Туре | Description | | | |
| 1 | XIN / CLKIN | I | Crystal connection or external reference frequency input. This pin has dual functions. It can be connected to either an external crystal or an external reference clock. | | | |
| 2 | XOUT | 0 | Crystal connection. If using an external reference, this pin must be left unconnected. | | | |
| 3 | GND | Р | Ground to entire chip. | | | |
| 4 | NC | - | No connect. | | | |
| 5 | CLOCKOUT | 0 | Spread spectrum low EMI output. | | | |
| 6 | VDD | Р | Power supply for the entire chip (5V). | | | |
| 7 | NC | - | No connect. | | | |
| 8 | NC | - | No connect. | | | |

Absolute Maximum Ratings

| Parameter | Rating | Unit |
|---|---|--|
| Voltage on any pin with respect to Ground | -0.5 to +7.0 | V |
| Storage temperature | -65 to +125 | °C |
| Operating temperature | 0 to 70 | °C |
| Max. Soldering Temperature (10 sec) | 260 | °C |
| Junction Temperature | 150 | °C |
| Static Discharge Voltage (As per JEDEC STD22- A114-B) | 2 | KV |
| | Voltage on any pin with respect to Ground Storage temperature Operating temperature Max. Soldering Temperature (10 sec) Junction Temperature Static Discharge Voltage | Voltage on any pin with respect to Ground -0.5 to +7.0 Storage temperature -65 to +125 Operating temperature 0 to 70 Max. Soldering Temperature (10 sec) Junction Temperature 150 Static Discharge Voltage |

DC Electrical Characteristics

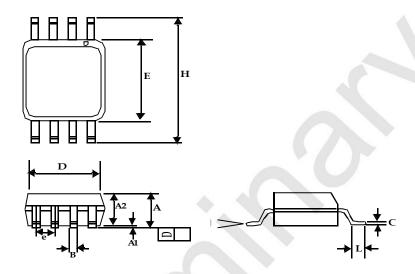
| Symbol | Parameter | Min | Тур | Max | Unit |
|------------------|--|-----------|------|-----------------------|------|
| V _{IL} | Input low voltage | GND - 0.3 | - | 0.8 | V |
| V _{IH} | Input high voltage | 2.0 | - | V _{DD} + 0.3 | V |
| I _{IL} | Input low current | - | 44 | - | μΑ |
| I _{IH} | Input high current | - | 66 | - | μΑ |
| I _{XOL} | X _{OUT} output low current (@ 0.4, V _{DD} = 5V) | - | 3 | - | mA |
| I_{XOH} | X _{OUT} output high current (@2.5V, V _{DD} = 5V) | - | 3 | - | mA |
| V_{OL} | Output low voltage (V _{DD} = 5V, I _{OL} = 20mA) | - | 1 | 0.4 | V |
| V_{OH} | Output high voltage (V _{DD} = 5V, I _{OH} = 20mA) | 2.5 | (| - | V |
| I _{CC} | Dynamic supply current normal mode (5V, 18MHz and 15pF loading) | - | 40 |)- | mA |
| I_{DD} | Static supply current standby mode | -) | 40 | - | μΑ |
| V_{DD} | Operating voltage | 4.75 | 5.0 | 5.25 | V |
| ton | Power up time (first locked clock cycle after power up) | | 0.18 | - | mS |
| Z _{OUT} | Clock out impedance | | 50 | - | Ω |

AC Electrical Characteristics

| Symbol | Parameter | | Min | Тур | Max | Unit |
|-------------------|---|-------------------------|-----|-------|-----|------|
| f _{IN} | Input frequency | | 12 | - | 22 | MHz |
| MODOUT | Output frequency | | 12 | - | 22 | MHz |
| f | Frequency Deviation | Input Frequency = 12MHz | - | -2.13 | - | % |
| f _d | | Input Frequency = 22MHz | | -0.62 | - | |
| t _{LH} * | Output rise time (measured at 0.8V to 2.0V) | | - | 440 | - | pS |
| t _{HL} * | Output fall time (meas | ured at 2.0V to 0.8V) | - | 300 | - | pS |
| t _{JC} | Jitter (cycle to cycle) | | - | - | 360 | pS |
| t _D | Output duty cycle | 45 | 50 | 55 | % | |

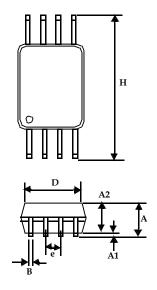
Package Information

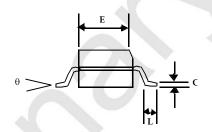
8-Pin SOIC Package



| | Dimensions | | | | |
|--------|-------------|-------|-------------|------|--|
| Symbol | Inc | hes | Millimeters | | |
| | Min | Max | Min | Max | |
| A1 | 0.004 | 0.010 | 0.10 | 0.25 | |
| Α | 0.053 | 0.069 | 1.35 | 1.75 | |
| A2 | 0.049 | 0.059 | 1.25 | 1.50 | |
| В | 0.012 | 0.020 | 0.31 | 0.51 | |
| С | 0.007 | 0.010 | 0.18 | 0.25 | |
| D | 0.193 BSC | | 4.90 BSC | | |
| Е | 0.154 BSC | | 3.91 BSC | | |
| е | 0.050 BSC | | 1.27 BSC | | |
| Н | 0.236 BSC | | 6.00 BSC | | |
| L | 0.016 0.050 | | 0.41 | 1.27 | |
| θ | 0° 8° | | 0° | 8° | |

8-Pin TSSOP



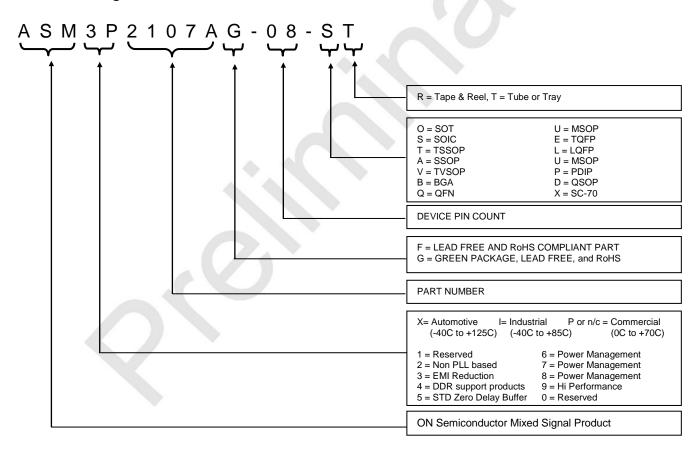


| | Dimensions | | | | |
|--------|------------|-------|-------------|------|--|
| Symbol | Incl | hes | Millimeters | | |
| | Min | Max | Min | Max | |
| Α | | 0.043 | | 1.10 | |
| A1 | 0.002 | 0.006 | 0.05 | 0.15 | |
| A2 | 0.033 | 0.037 | 0.85 | 0.95 | |
| В | 0.008 | 0.012 | 0.19 | 0.30 | |
| С | 0.004 | 0.008 | 0.09 | 0.20 | |
| D | 0.114 | 0.122 | 2.90 | 3.10 | |
| E | 0.169 | 0.177 | 4.30 | 4.50 | |
| е | 0.026 BSC | | 0.65 BSC | | |
| Н | 0.252 | BSC | 6.40 BSC | | |
| L | 0.020 | 0.028 | 0.50 | 0.70 | |
| θ | 0° | 8° | 0° | 8° | |

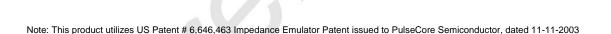
Ordering Codes

| Part Number | Marking | Package | Temperature |
|-------------------|----------|-------------------------------------|-------------|
| ASM3P2107AF-08-SR | 3P2107AF | 8-PIN SOIC, TAPE AND REEL, Pb Free | Commercial |
| ASM3P2107AF-08-ST | 3P2107AF | 8-PIN SOIC, TUBE, Pb Free | Commercial |
| ASM3P2107AF-08-TR | 3P2107AF | 8-PIN TSSOP, TAPE AND REEL, Pb Free | Commercial |
| ASM3P2107AF-08-TT | 3P2107AF | 8-PIN TSSOP, TUBE, Pb Free | Commercial |
| ASM3P2107AG-08-SR | 3P2107AG | 8-PIN SOIC, TAPE AND REEL, Green | Commercial |
| ASM3P2107AG-08-ST | 3P2107AG | 8-PIN SOIC, TUBE, Green | Commercial |
| ASM3P2107AG-08-TR | 3P2107AG | 8-PIN TSSOP, TAPE AND REEL, Green | Commercial |
| ASM3P2107AG-08-TT | 3P2107AG | 8-PIN TSSOP, TUBE, Green | Commercial |

Device Ordering Information



Licensed under US patent #5,488,627, #6,646,463 and #5,631,920.



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